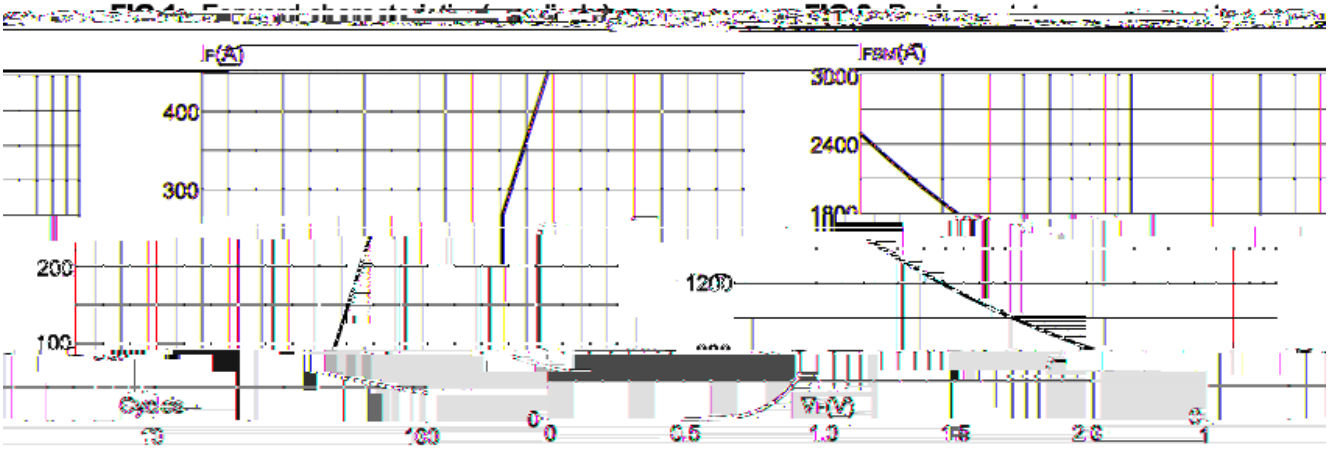




mum transient thermal impedance

Junction to case (per diode)

FIG.3: Forward current vs. case temperature

FIG.4: Maxi

